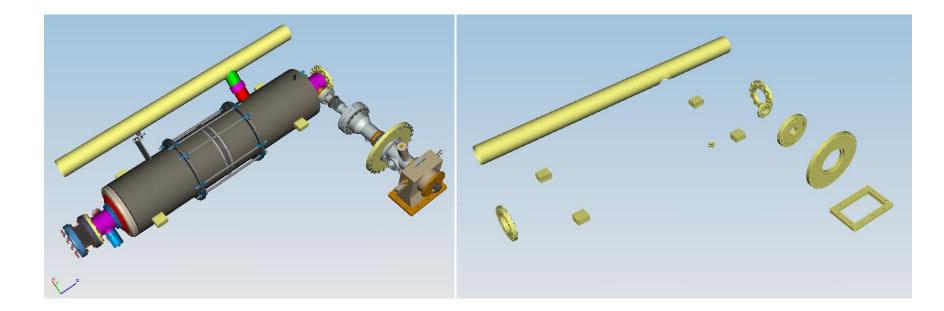
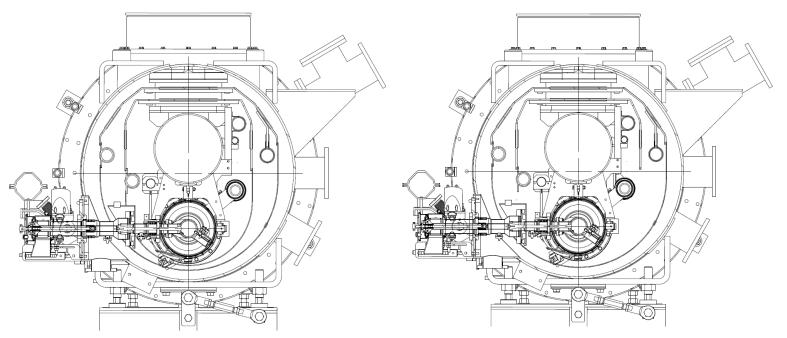
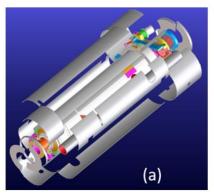
- 1. Plug-compatible interface design
 - Interface of the components for plug-compatibility
 - Magnetic shield design should be included.
 - Outer shield (DESY/FNAL) or Inner shield (KEK)
 - Design of the components



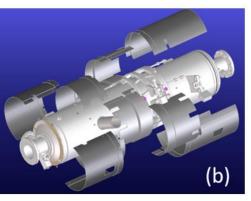
- 2. Thermal shield design
 - One shield or two shields concepts
 - Thermal specification
 - Cooling scheme
 - Mechanical design of components
 - Thermal intercept design
 - Cost comparison including the cryogenic system



- 3. Magnetic shield design
 - Outer magnetic shield and inner magnetic shield
 - Comparison of the procedures and the cost of assembly in cryomodule

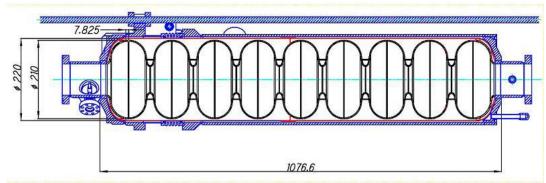


DESY cavity outer magnetic shield



FNAL cavity outer magnetic shield

KEK cavity inner magnetic shield (red line)



- 4. Assembly of cold components and alignment strategy of cavities and quadrupole package.
- 5. High pressure regulation
 - Specific requirements of components for the regulation
 - This work should be discussed with the cryogenic group.